

DMG7401SFGQ

P-CHANNEL ENHANCEMENT MODE MOSFET PowerDI3333-8

Product Summary

BV _{DSS}	Rds(on) Max	I _D Max T _A = +25°C
201/	13mΩ @ V _{GS} = -10V	-9.8A
-30V	25mΩ @ V _{GS} = -4.5V	-7.0A

Description

This MOSFET is designed to minimize the on-state resistance (RDS(ON)) yet maintain superior switching performance, making it ideal for high-efficiency power management applications.

Applications

- Backlighting
- · Power management functions
- DC-DC converters

Features and Benefits

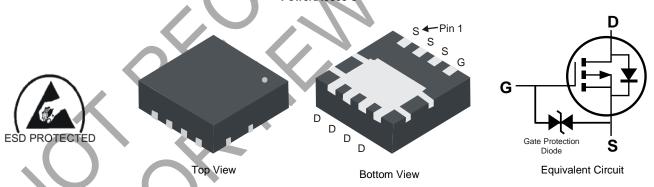
- Low RDS(ON) Ensures On-State Losses Are Minimized
- Small Form Factor Thermally Efficient Package Enables Higher Density End Products
- Occupies Just 33% of The Board Area Occupied by SO-8 Enabling Smaller End Product
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The DMG7401SFGQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

https://www.diodes.com/quality/product-definitions/

Mechanical Data

- Package: PowerDI[®]3333-8
- Package Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.0174 grams (Approximate)

PowerDI3333-8



Ordering Information (Note 4)

Part Number	Backago	Packing		
Fait Nullibei	Package	Qty.	Carrier	
DMG7401SFGQ-7	PowerDI3333-8	2,000	Tape & Reel	
DMG7401SFGQ-13	PowerDI3333-8	3,000	Tape & Reel	

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.



Marking Information



G75 = Product Marking Code YYYW = Date Code Marking
YY = Last Two Digits of Year (ex: 22 for 2022)
WW = Week Code (01 to 53)

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic			Symbol	Value	Unit
Drain-Source Voltage			VDSS	-30	V
Gate-Source Voltage			V _{GSS}	±25	V
Ocationary Davis Ocasas (Note 2017)		$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	lo	-9.8 -7.7	А
Continuous Drain Current (Note 6) V _{GS} = -10V	t<10s	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I _D	-13.5 -10.8	А
Maximum Continuous Body Diode Forward Current (Note 6)			ls	-3.0	Α
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)			I _{DM}	-80	Α
Avalanche Current (Notes 7 & 8)			lar	-14	Α
Repetitive Avalanche Energy (Notes 7 & 8) L = 1mH			EAR	104	mJ

Thermal Characteristics

Characteristic		Symbol	Value	Unit	
Total Power Dissipation (Note 5)	$T_A = +25$ °C	PD	0.94	W	
Total Power Dissipation (Note 5)	$T_A = +70$ °C	PD	0.6		
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	Davi	137	°C/W	
Thermal Resistance, Junction to Ambient (Note 5)	t<10s	Reja	82	°C/W	
Total Power Dissipation (Note 6)	$T_A = +25$ °C	ç	2.2	W	
Total Power Dissipation (Note 6)	T _A = +70°C	PD	1.3	V V	
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	Rеja	60	°C/W	
Thermal Resistance, Junction to Ambient (Note 0)	t<10s	Keja	36	°C/W	
Thermal Resistance, Junction to Case (Note 6)	$R_{ heta JC}$	3.0	°C/W		
Operating and Storage Temperature Range	TJ, TSTG	-55 to +150	°C		

5. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
6. Device mounted on FR-4 substrate PC board, 2oz copper, with 1-inch square copper plate.

7. IAR and EAR ratings are based on low frequency and duty cycles to keep $T_J = +25$ °C.



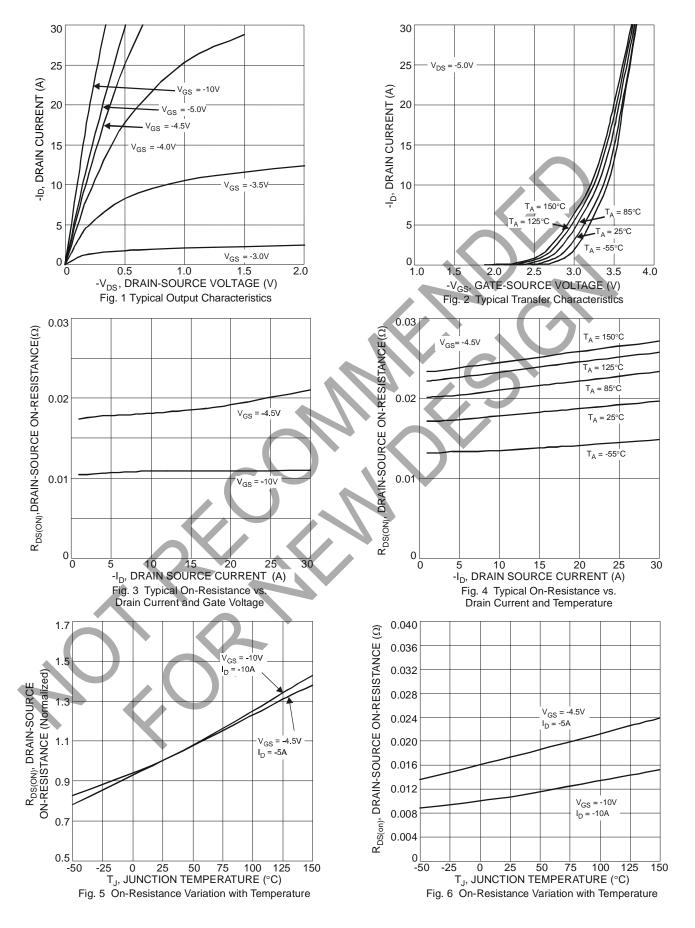
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 8)						
Drain-Source Breakdown Voltage		-30	_	_	V	$V_{GS} = 0V$, $I_{D} = -250\mu A$
Zero Gate Voltage Drain Current		_	_	-1	μΑ	$V_{DS} = -30V, V_{GS} = 0V$
Gate-Source Leakage	I _{GSS}	_	_	±10	μΑ	$V_{GS} = \pm 20V$, $V_{DS} = 0V$
ON CHARACTERISTICS (Note 8)	ON CHARACTERISTICS (Note 8)					
Gate Threshold Voltage	Vgs(th)	-1.7	_	-3.0	V	$V_{DS} = V_{GS}$, $I_D = -250\mu A$
			9	11		Vgs = -20V, ID = -12A
Static Drain-Source On-Resistance	RDS(ON)	_	10	13	mΩ	$V_{GS} = -10V, I_{D} = -9A$
		_	17	25		$V_{GS} = -4.5V$, $I_{D} = -5A$
Forward Transfer Admittance	Y _{fs}	_	21	_	S	$V_{DS} = -5V$, $I_{D} = -10A$
DYNAMIC CHARACTERISTICS (Note 9)						
Input Capacitance	Ciss	_	2,246	2,987	pF	15V V 0V
Output Capacitance	Coss	_	352	468	pF	$V_{DS} = -15V, V_{GS} = 0V,$ f = 1.0MHz
Reverse Transfer Capacitance	Crss	_	294	391	pF	1 = 1.00112
Gate Resistance	Rg	_	5.1	10	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1.0MHz$
Total Gate Charge (V _{GS} = -4.5V)	Qg	_	20.5	30	nC	
Total Gate Charge (V _{GS} = -10V)	Qg	_	41	58	nC	V _{DS} = -15V, I _D = -12A
Gate-Source Charge	Qgs		7.6	_	nC	VDS = -15V, ID = -12A
Gate-Drain Charge	Q_{gd}	K	8.0	_	nC	
Turn-On Delay Time	td(ON)		11.3	23	ns	
Turn-On Rise Time	t _R	-	15.4	31	ns	V _{DD} = -15V, V _{GS} = -10V,
Turn-Off Delay Time	tD(OFF)	1	38.0	61	ns	$R_L = 1.25\Omega$, $R_G = 3\Omega$
Turn-Off Fall Time	tF		22.0	38	ns	
BODY DIODE CHARACTERISTICS						
Diode Forward Voltage	VsD		-0.7	-1.0	V	$V_{GS} = 0V$, $I_{S} = -1A$
Reverse Recovery Time (Note 9)	t _{RR}		20	31	ns	la = 0.5A dl/dt = 100A/ug
Reverse Recovery Charge (Note 9)	Qrr		9.5	18	nC	I _S = -9.5A, dl/dt = 100A/μs

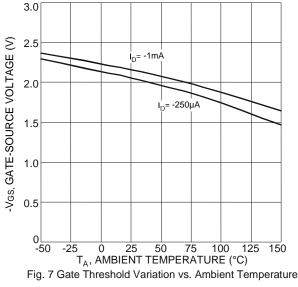
Notes:

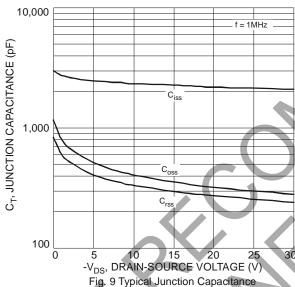
8. Short duration pulse test used to minimize self-heating effect.
9. Guaranteed by design. Not subject to product testing.

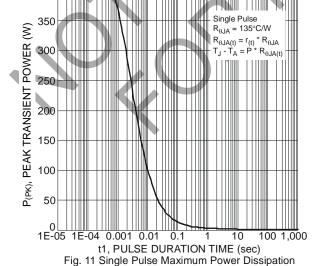




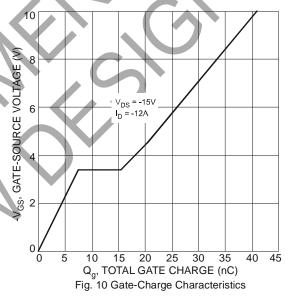


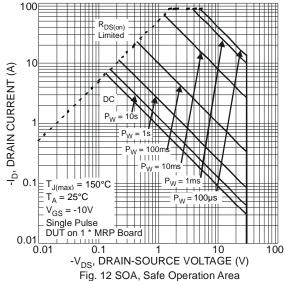






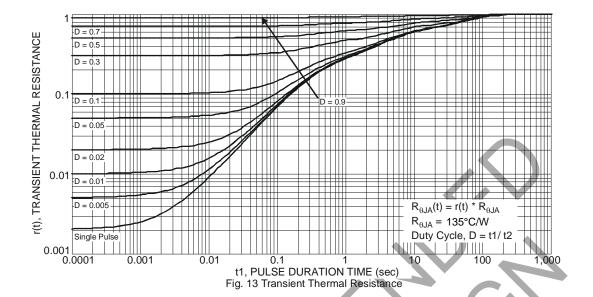
30 25 -I_S, SOURCE CURRENT (A) 20 15 T_△= 25°C 0 0.6 0.8 1.0
-V_{SD}, SOURCE-DRAIN VOLTAGE (V)
Fig. 8 Diode Forward Voltage vs. Current 0.4 1.2





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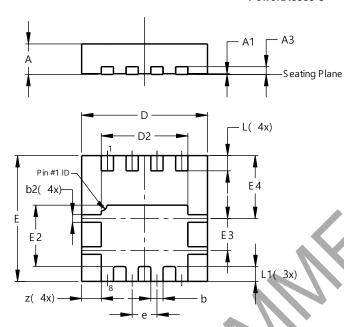




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI3333-8

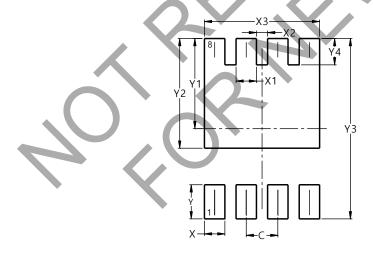


PowerDI3333-8						
Dim	Min	Max	Тур			
Α	0.75	0.85	0.80			
A1	0.00	0.05	0.02			
A3	-	_	0.203			
b	0.27	0.37	0.32			
b2	0.15	0.25	0.20			
D	3.25	3.35	3.30			
D2	2.22	2.32	2.27			
E	3.25	3.35	3.30			
E2	1.56	1.66	1.61			
E3	0.79	0.89	0.84			
E4	1.60	1.70	1.65			
е		-2	0.65			
4	0.35	0.45	0.40			
L1		_	0.39			
z		_	0.515			
All Dimensions in mm						

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI3333-8



Dimensions	Value (in mm)		
С	0.650		
Х	0.420		
X1	0.420		
X2	0.230		
Х3	2.370		
Y	0.700		
Y1	1.850		
Y2	2.250		
Y3	3.700		
Y4	0.540		



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